

SGH30N60RUF

Short Circuit Rated IGBT

General Description

Fairchild's RUF series of Insulated Gate Bipolar Transistors (IGBTs) provide low conduction and switching losses as well as short circuit ruggedness. The RUF series is designed for applications such as motor control, uninterrupted power supplies (UPS) and general inverters where short circuit ruggedness is a required feature.

Features

- Short circuit rated 10us @ $T_C = 100$ °C, $V_{GE} = 15$ V
- High speed switching
- Low saturation voltage : $V_{CE(sat)} = 2.2 \text{ V} @ I_C = 30 \text{A}$
- High input impedance

Applications

AC & DC motor controls, general purpose inverters, robotics, and servo controls.



TO-3P



Absolute Maximum Ratings T_C = 25°C unless otherwise noted

Symbol	Description	10.7	SGH30N60RUF	Units
V _{CES}	Collector-Emitter Voltage	97///p +	600	V
V _{GES}	Gate-Emitter Voltage		± 20	V
I _C	Collector Current	@ T _C = 25°C	48	Α
	Collector Current	@ T _C = 100°C	30	А
I _{CM (1)}	Pulsed Collector Current		90	А
T _{SC}	Short Circuit Withstand Time	@ T _C =100°C	10	us
PD	Maximum Power Dissipation	@ $T_C = 25^{\circ}C$	235	W
	Maximum Power Dissipation	@ T _C = 100°C	90	W
T _J	Operating Junction Temperature		-55 to +150	°C
T _{stg}	Storage Temperature Range		-55 to +150	°C
T _L	Maximum Lead Temp. for Soldering Purposes, 1/8" from Case for 5 Seconds		300	°C

Notes:
(1) Repetitive rating: Pulse width limited by max. junction temperature

Thermal Characteristics

Symbol	Parameter	Тур.	Max.	Units
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case		0.53	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient		40	°C/W

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Units
Off Char	racteristics					
BV _{CES}	Collector-Emitter Breakdown Voltage	$V_{GE} = 0V, I_{C} = 250uA$	600			V
ΔB _{VCES} / ΔΤ _J	Temperature Coefficient of Breakdown Voltage	$V_{GE} = 0V$, $I_C = 1mA$		0.6		V/°C
I _{CES}	Collector Cut-Off Current	$V_{CE} = V_{CES}, V_{GE} = 0V$			250	uA
I _{GES}	G-E Leakage Current	$V_{GE} = V_{GES}, V_{CE} = 0V$			± 100	nA
On Char	acteristics					
V _{GE(th)}	G-E Threshold Voltage	$I_C = 30$ mA, $V_{CE} = V_{GE}$	5.0	6.0	8.5	V
	Collector to Emitter	$I_C = 30A$, $V_{GE} = 15V$		2.2	2.8	V
V _{CE(sat)}	Saturation Voltage	I _C = 48A, V _{GE} = 15V		2.5		V
Dynamic	Characteristics					
C _{ies}	Input Capacitance	$V_{CE} = 30V_{VGE} = 0V_{VGE}$		1970		рF
C _{oes}	Output Capacitance	f = 1MHz		310		рF
C _{res}	Reverse Transfer Capacitance	1 - 11/11/2		74		pF
	ng Characteristics Turn-On Delay Time			30		ns
t _{d(on)}	Turn-On Delay Time			30		ns
t _r	Rise Time	.,		65		ns
t _{d(off)}	Turn-Off Delay Time	$V_{CC} = 300 \text{ V}, I_{C} = 30\text{A},$		54	80	ns
t _f	Fall Time	$R_G = 7\Omega$, $V_{GE} = 15V$,		138	200	ns
E _{on}	Turn-On Switching Loss	Inductive Load, T _C = 25°C		919		uJ
E _{off}	Turn-Off Switching Loss			814		uJ
E _{ts}	Total Switching Loss			1733	2430	uJ
t _{d(on)}	Turn-On Delay Time			34		ns
t _r	Rise Time			67		ns
t _{d(off)}	Turn-Off Delay Time	$V_{CC} = 300 \text{ V}, I_C = 30\text{A},$		60	90	ns
t _f	Fall Time	$R_G = 7\Omega, V_{GE} = 15V,$		281	400	ns
E _{on}	Turn-On Switching Loss	Inductive Load, T _C = 125°C		921		uJ
E _{off}	Turn-Off Switching Loss			1556		uJ
E _{ts}	Total Switching Loss			2477	3470	uJ
T _{sc}	Short Circuit Withstand Time	$V_{CC} = 300 \text{ V}, V_{GE} = 15 \text{V}$ @ $T_C = 100 ^{\circ}\text{C}$	10			us
Q_g	Total Gate Charge	$V_{CE} = 300 \text{ V}, I_{C} = 30\text{A},$		85	120	nC
Q _{ge}	Gate-Emitter Charge	$V_{CE} = 300 \text{ V}, I_{C} = 30A,$ $V_{GE} = 15V$		17	25	nC
Q_{gc}	Gate-Collector Charge	VGE - 10 V		39	55	nC
L _e	Internal Emitter Inductance	Measured 5mm from PKG		14		nΗ

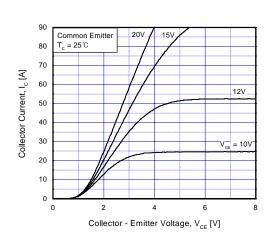


Fig 1. Typical Output Characteristics

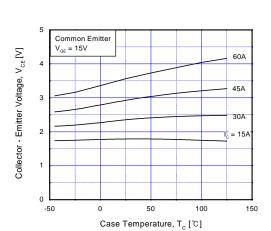


Fig 3. Saturation Voltage vs. Case
Temperature at Variant Current Level

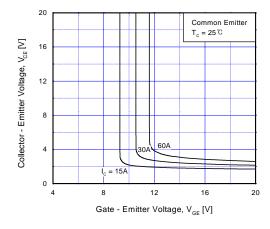


Fig 5. Saturation Voltage vs. V_{GE}

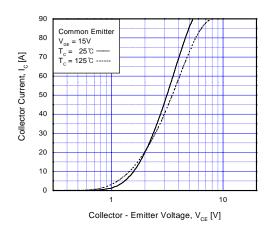


Fig 2. Typical Saturation Voltage Characteristics

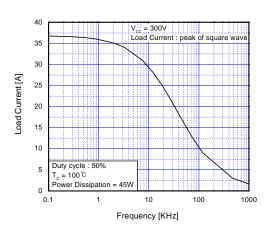


Fig 4. Load Current vs. Frequency

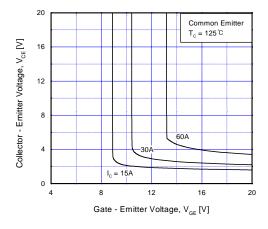


Fig 6. Saturation Voltage vs. V_{GE}

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Ton

100

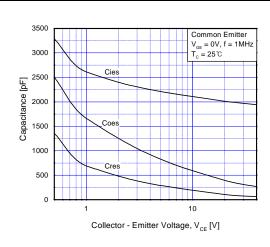
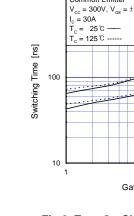


Fig 7. Capacitance Characteristics



Common Emitter

Fig 8. Turn-On Characteristics vs. Gate Resistance

10

Gate Resistance, $R_{_{G}}[\Omega]$

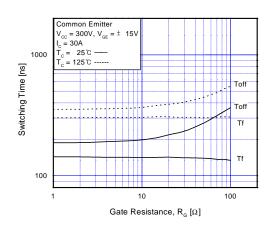


Fig 9. Turn-Off Characteristics vs.
Gate Resistance

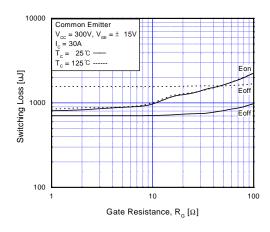


Fig 10. Switching Loss vs. Gate Resistance

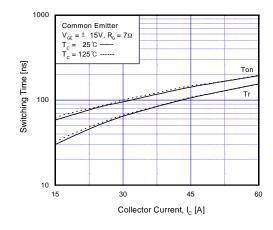


Fig 11. Turn-On Characteristics vs. Collector Current

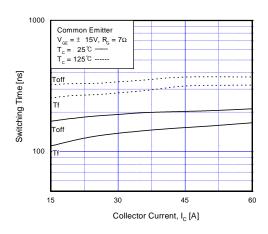
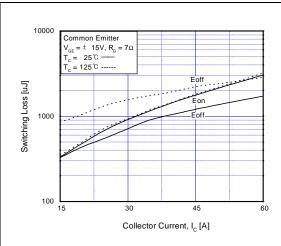


Fig 12. Turn-Off Characteristics vs. Collector Current

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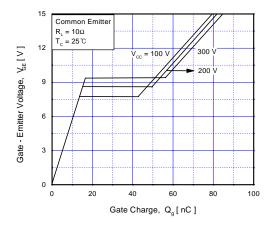
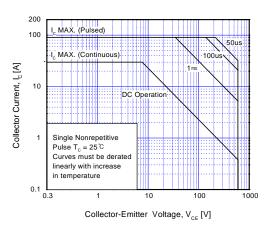


Fig 13. Switching Loss vs. Collector Current

Fig 14. Gate Charge Characteristics



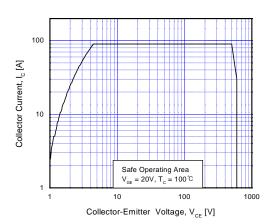


Fig 15. SOA Characteristics

Fig 16. Turn-Off SOA Characteristics

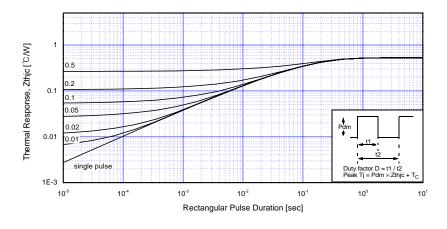
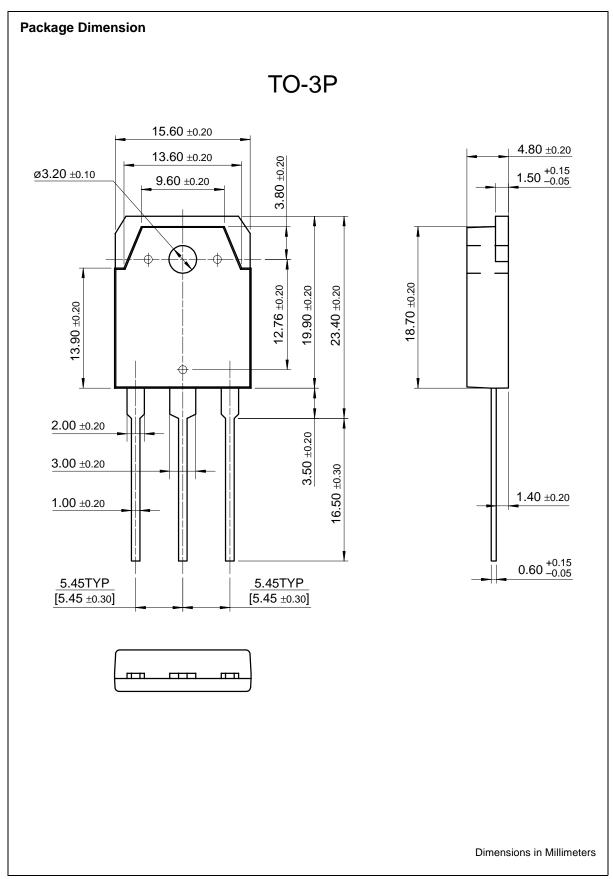


Fig 17. Transient Thermal Impedance of IGBT



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